Rev. 11-3/98

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DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

(X)	Original () Supplemental () Subs	titute () PCT () Design	
to my name; that I verily belie	rentor, I hereby declare that: my residence we that I am the original, first and sole inverse s are named below) of the subject matter wh	entor (if only one name is listed below) o	r an original, first and
Title: Method of	making through hole wi	th laser, copper-clad	
laminate s for making of which is described and clair () the attached specification	ned in:	e, and auxiliary mate	rial
() the specification in the ar	oplication Serial No (if applicable)	iled; o, or, filed	, and as amended
Thereby state that I have review any amendment(s) referred to the large of the larg	ewed and understand the content of the able to above. close to the Patent and Trademark Office		
for patent or inventor's certific	ederal Regulations, §1.56. under Title 35, United States Code, §119 (a cate listed below and have also identified be application on which priority is claimed:	and §172 if this application is for a Design low any application for patent or invento	n) of any application(s) or's certificate having
20 5 			
COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan Japan	68357/98 140472/98	March 18,1998 May 7,1998	X X
Japan	145206/98	May 12,1998	X
Japan	145205/98	May 12,1998	x
Japan	250447/98	August 20,1998	
Japan	216411/98	July 15,1998	x

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not dislosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

Country	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	166324/98	May 29, 1998	X
Japan	167759/98	June 1, 1998	X
Japan	167760/98	June 1, 1998	X

And I hereby appoint John T. Miller, Reg. No. 21,120; Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Jeffrey Nolton, Reg. No. 25,408; Warren M. Cheek, Jr., Reg. No. 33,367; Nils E. Pedersen, Reg. No. 33,145 and Charles R. Watts. Reg. No. 33,142, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., attorneys to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys named herein to accept and follow instructions from ________ Kobayashi Patent Office ______ as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

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Epunishable by fine or	that all statements made herein of my of different that these statements were not imprisonment, or both, under Section ardize the validity of the application or Cobanguisia Obergushi	nade with the knowledge that wing 1001 of Title 18 of the United any patent issuing thereon.	ed States Code, and the lited States Code, and that su Date March 8,1999	ke so made ar ch willful fals
3rd Inventor	Jasuo Janaka		.	
4th Inventor	oshihiro Kato		Date March 8,1999	
				190000
7th Inventor			Date	
The above appl	ication may be more particularly identi	ified as follows:		
U.S. Application Seri	al No	Filing Date		
	Number			